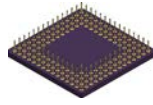


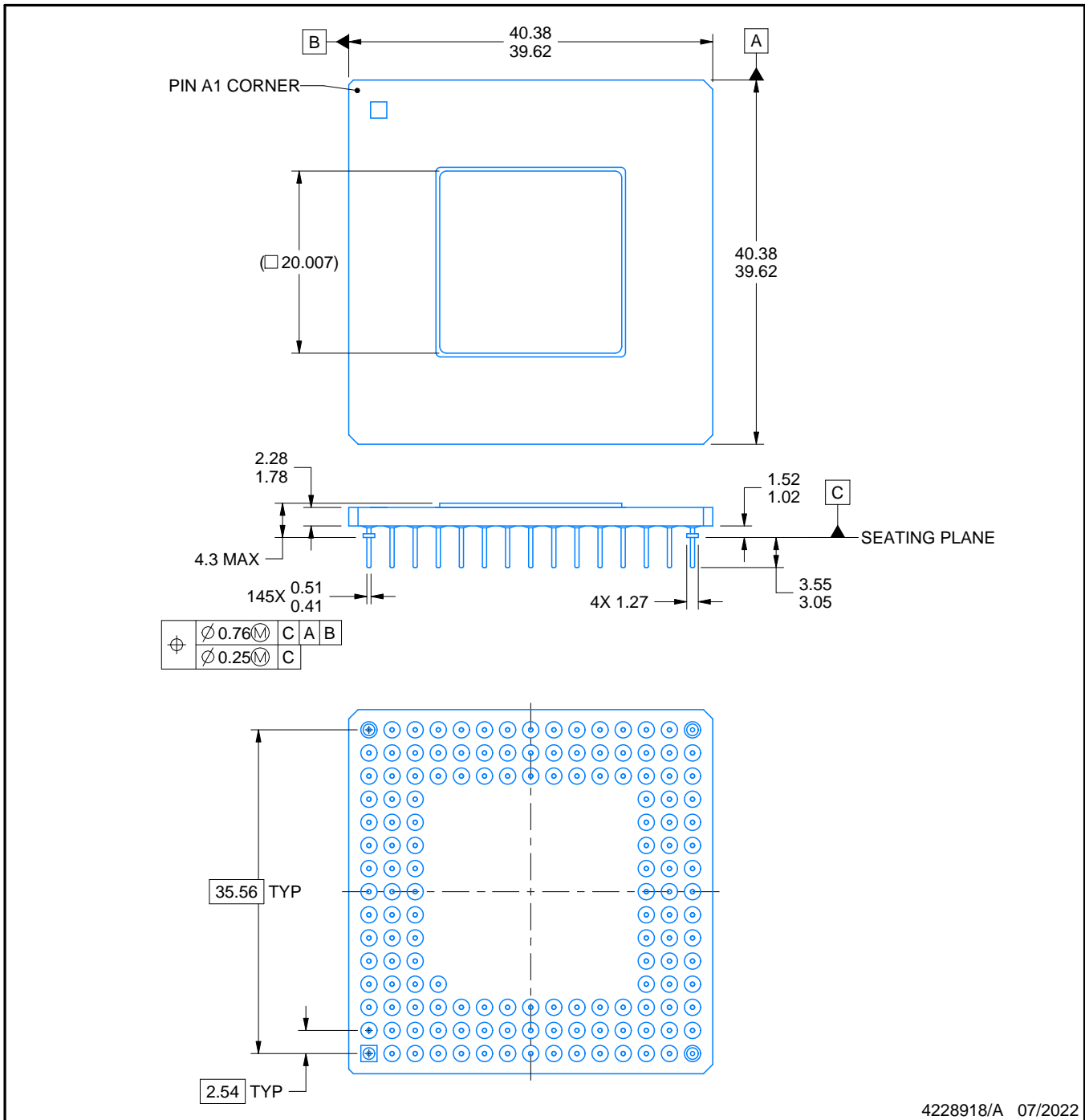
GB0145A



PACKAGE OUTLINE

CPGA - 4.3 mm max height

CERAMIC PIN GRID ARRAY



4228918/A 07/2022

NOTES:

1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. Index mark can appear on top or bottom, depending on package vendor.
4. This package can be hermetically sealed with metal lids or with ceramic lids using glass frit.
5. The pins can be gold plated or solder dipped.
6. Falls within MIL STD 1835 CMGA7-PN

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